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July 31, 2000

VIA EXPRESS MAIL NO. EL417461943US

Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

Re: Patent Application for "Wafer/Interposer Assembly Apparatus and Method"
Inventor: Jerry D. Kline
Our File No.: 121251-1004

Dear Sir:

Enclosed for filing in connection with the above-referenced U.S. patent application, please find the following:

- (1) Patent Application (37 pages plus 8 sheets of informal drawings);
- (2) Fee Calculation Sheet; and
- (3) Return Postcard.

Please file the above documents and return the file-stamped postcard to our offices. The Commissioner is hereby authorized to charge the filing fee of \$552.00 and any additional fees which may be required by this paper to Deposit Account No. 07-0153.

Thank you for your assistance. Should you have any questions, please call me.

Respectfully submitted,

GARDERE & WYNNE, L.L.P.

Daniel J. Chalker
Registration No. 40,552

DJC/hrh

Enclosures

cc: Sanford E. Warren, Jr.

APPLICATION FOR U.S. PATENT
TRANSMITTAL FORM

Attorney Docket No.: 121251-1004

Box: Patent Application
Assistant Commissioner for Patents
Washington, DC 20231

"EXPRESS MAILING" Mailing Label No. EL417461943US Date of
Deposit: July 31, 2000. I hereby certify that this paper is being deposited
with the U.S. Postal Service Express Mail Post Office to Addressee
Service under 37 CFR 1.10 on the date shown above and is addressed to
the Box Patent Application, Asst Commissioner for Patents, Washington,
D.C. 20231.

Daniel J. Chalk
Daniel J. Chalk

1c886 U.S. PTO
09/628531
07/31/00

Sir:

Transmitted herewith for filing is the patent application of:

Inventor(s): Jerry D. Kline of Argyle, Texas

For: "Wafer/Interposer Assembly Apparatus and Method"

Enclosed are: 8 Sheet(s) of informal drawings;
27 pages of Specification;
9 pages of Claims; and
1 page of Abstract.

FEE CALCULATION					FEE
	NUMBER		NUMBER EXTRA	RATE	BASIC FEE \$ 345.00
Total Claims	43	-20 =	23	x\$ 9 =	\$ 207.00
Independent Claims	3	- 3 =	0	x\$ 39 =	\$ 0.00
Total Filing Fee					\$ 552.00

The Commissioner is hereby authorized to charge the filing fee of \$552.00 and any additional fees which may be required, or credit any overpayment to Deposit Account No. 07-0153. **This form is submitted in duplicate.**

All correspondence related to this application may be addressed to the undersigned at:

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Date: July 31, 2000

Daniel J. Chalk
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